

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10467	REV: A	SUN REU:	Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 10/8/2	2014 4:19:20	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10467	REV: A	SUN REV:	Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 10/8/2	2014 4:19:21	PM	TEXAS INSTRUMENTS

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